

ChipFET™

DATE 19 MAY 2009

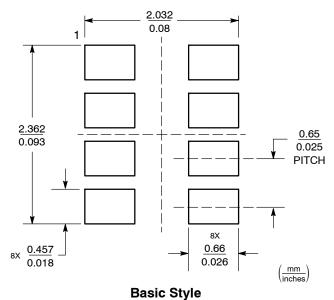
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- MOLD GATE BURRS SHALL NOT EXCEED 0.13 MM PER SIDE. LEADFRAME TO MOLDED BODY OFFSET IN HORIZONTAL
- AND VERTICAL SHALL NOT EXCEED 0.08 MM.
 DIMENSIONS A AND B EXCLUSIVE OF MOLD GATE BURRS.
- NO MOLD FLASH ALLOWED ON THE TOP AND BOTTOM LEAD

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.00	1.05	1.10	0.039	0.041	0.043
b	0.25	0.30	0.35	0.010	0.012	0.014
С	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	1.55	1.65	1.70	0.061	0.065	0.067
е	0.65 BSC			0.025 BSC		
e1	0.55 BSC			0.022 BSC		
L	0.28	0.35	0.42	0.011	0.014	0.017
HE	1.80	1.90	2.00	0.071	0.075	0.079
θ	5° NOM			5° NOM		

STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. SOURCE 1	PIN 1. ANODE	PIN 1. COLLECTOR	PIN 1. ANODE	PIN 1. ANODE
2. GATE 1	2. ANODE	COLLECTOR	ANODE	2. DRAIN
SOURCE 2	SOURCE	COLLECTOR	DRAIN	3. DRAIN
4. GATE 2	4. GATE	4. BASE	DRAIN	4. GATE
5. DRAIN 2	5. DRAIN	EMITTER	SOURCE	5. SOURCE
6. DRAIN 2	6. DRAIN	COLLECTOR	GATE	6. DRAIN
7. DRAIN 1	CATHODE	COLLECTOR	CATHODE	7. DRAIN
8. DRAIN 1	CATHODE	COLLECTOR	CATHODE	8. CATHODE / DRAIN
	PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1	PIN 1. SOURCE 1 PIN 1. ANODE 2. GATE 1 2. ANODE 3. SOURCE 2 3. SOURCE 4. GATE 2 4. GATE 5. DRAIN 2 5. DRAIN 6. DRAIN 2 6. DRAIN 7. DRAIN 1 7. CATHODE	PIN 1. SOURCE 1 PIN 1. ANODE 2. GATE 1 2. ANODE 2. COLLECTOR 2. SOURCE 2 3. SOURCE 3. COLLECTOR 4. GATE 2 4. GATE 4. BASE 5. DRAIN 5. EMITTER 6. DRAIN 6. COLLECTOR 7. DRAIN 1 7. CATHODE 7. COLLECTOR	PIN 1. SOURCE 1 PIN 1. ANODE PIN 1. COLLECTOR PIN 1. ANODE 2. GATE 1 2. ANODE 2. COLLECTOR 2. ANODE 3. SOURCE 2 3. SOURCE 3. COLLECTOR 2. ANODE 4. GATE 2 4. GATE 4. BASE 4. DRAIN 5. DRAIN 2 5. DRAIN 5. EMITTER 5. SOURCE 6. DRAIN 2 6. DRAIN 6. COLLECTOR 6. GATE 7. DRAIN 1 7. CATHODE 7. COLLECTOR 7. CATHODE

SOLDERING FOOTPRINT



GENERIC MARKING DIAGRAM*



= Specific Device Code XXX

М = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

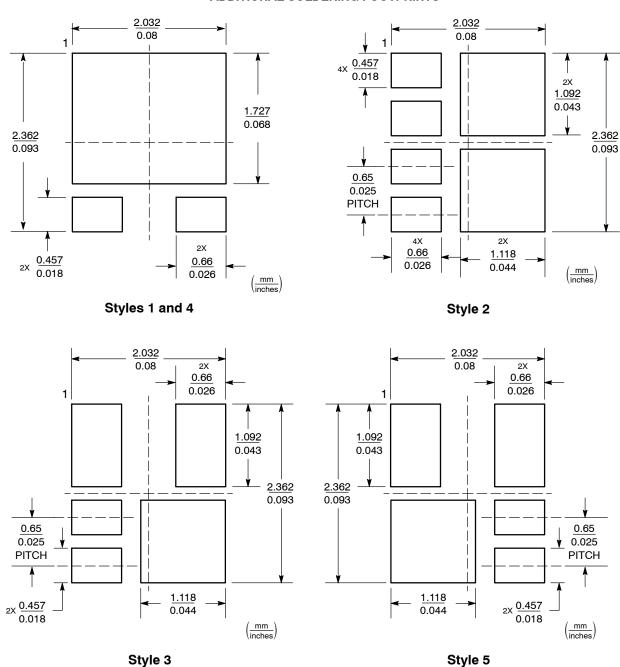
OPTIONAL SOLDERING FOOTPRINTS ON PAGE 2

DOCUMENT NUMBER:	98AON03078D	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	ChipFET		PAGE 1 OF 2	

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the

DATE 19 MAY 2009

ADDITIONAL SOLDERING FOOTPRINTS*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER: 98AON03078D		Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	ChipFET		PAGE 2 OF 2	

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.